SURFACE MOUNT RECTIFIER Voltage 50 to 1000 Volt Current 1 Ampere

Features

- Plastic package has Underwriters Laboratory Flammability
- Classification 94V-O
- For surface mounted applications in order to optimize board space
- Easy pick and place
- Glass passivated junction
- Complete device submersible temperature of 260°C for 10 seconds in solder bath
- Lead free in compliance with EU RoHS 2011/65/EU directive
- Green molding compound as per IEC61249 Std. . (Halogen Free)
- AEC-Q101 qualified (Automotive grade with suffix "Q".)
- Exsemi technology



Mechanical Data

- Case: JEDEC SMAF molded plastic
- Terminals: Solder plated, solderable per MIL-STD-750,Method 2026
- Polarity: Color band denotes cathode end

MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS

Ratings at 25°C ambient temperature unless otherwise specified. Single phase , half wave ,60Hz, resistive or inductive load. For capacitive load , derate current by 20%.

PARAMETER	SYMBOL	S1AF	S1BF	S1DF	S1GF	S1JF	S1KF	S1MF	UNIT
Maximum Recurrent Peak Reverse Voltage	V _{RRM}	50	100	200	400	600	800	1000	V
Maximum RMS Voltage	V _{RMS}	35	70	140	280	420	560	700	V
Maximum DC Blocking Voltage	V _{DC}	50	100	200	400	600	800	1000	V
Maximum Average Forward Current at T _L =100 °C	I _{F(AV)}	1				А			
Peak Forward Surge Current : 8.3ms single half sine-wave superimposed on rated load	I _{FSM}	30				А			
Maximum Forward Voltage at 1A	V _F	1.1				V			
Maximum DC Reverse Current at Rated DC Blocking T_J =25°C Voltage T_J =125°C	I _R	5 50				μА			
Typical Junction Capacitance (Notes 1)	C J	12			рF				
Typical Junction Resistance (Notes 2)	$R_{_{\theta JA}}$	35 75			°C / W				
Operating and Storage Temperature Range	T _J ,T _{STG}	-55 to +150			°C				

NOTES:

- 1. Measured at 1 Mhz and Applied Vr = 4 volts.
- 2. 8mm² (0.013 mm thick) land areas.

RATING AND CHARACTERISTIC CURVES

Fig.1 FORWARD CURRENT DERATING CURVE

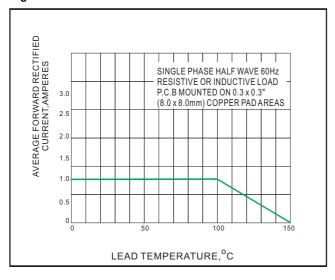


Fig.2 TYPICAL INSTANTANEOUS FORWARD CHARACTERISTICS

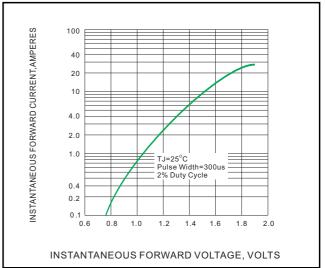


Fig.3-TYPICAL REVERSE CHARACTERISTIC

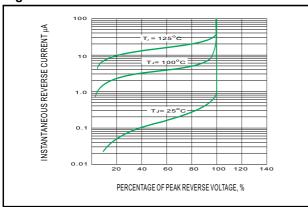


Fig.4 MAXIMUM NON REPETITIVE PEAK SURGE CURRENT

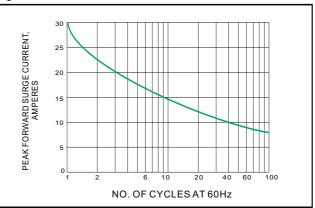
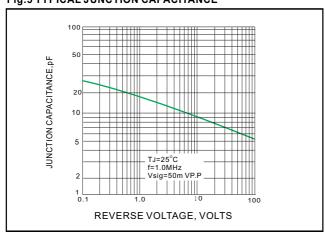
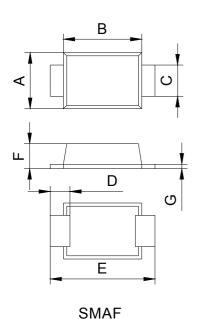


Fig.5 TYPICAL JUNCTION CAPACITANCE



Dfimensfions SMAF



	Dimensions						
Ref.	Millin	neters	Inches				
	Min.	Max.	Min.	Max.			
Α	2.40	2.80	0.094	0.110			
В	3.25	3.70	0.128	0.146			
С	1.30	1.60	0.051	0.063			
D	0.55	1.20	0.022	0.047			
E	4.40	4.90	0.173	0.193			
F	0.90	1.40	0.035	0.055			
G	0.10	0.30	0.004	0.012			

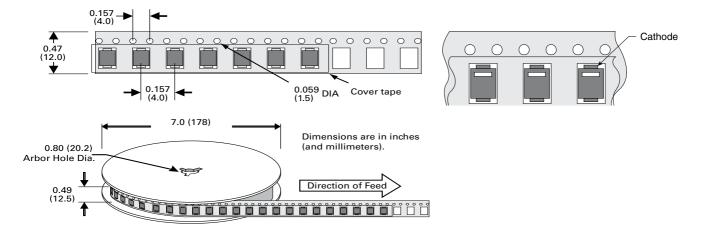
Note:

- 1. Controlling dimension:in millimeters.
- 2.General tolerance:± 0.05mm.
- 3. The pad layout is for reference purposes only.

Packaging

Part number	Component Package	Quantity	Packaging Option	Packaging Specification		
S1XF	SMAF	5000	Tape & Reel - 12mm tape/13" reel	EIA STD RS-481		

Tape and Reel Specification



Note: Devices are packde in accordance with EIA standard RS-481-Aand specification given above.